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PRODUCT SPECIFICATIONS

MODEL No.

TACT SWITCHES (MT 1500D)

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1. Ger	neral								
1.1 S	соре		This Specification de	scribes the physi	cal and electri	cal characte	ristics for a ta	ct	
			switch. It also define	s test methods ar	nd sequencing	for product	qualification te	esting.	
1.2 Operating temperature range			-20 $^\circ \mathrm{C}~\sim$ 70 $^\circ \mathrm{C}$ (norma	al humidity, norm	al pressure)				
1.3 Storage temperature range $-40^\circ\!\!\mathrm{C}\sim85^\circ\!\!\mathrm{C}$ (normal humidity, normal press				al pressure)					
1.4 Test conditions Test and measurements shall be made by the following cor				ing conditio	ns.				
			Temperature	:-5~35°C					
			Relative humidity	: 45~85%					
			Air pressure : $86 \sim 106$ kPa ($860 \sim 106$ 0 mbar)						
			In case of questions	for the judgment	made, tests				
			should be conducted by the following conditions.						
			Temperature						
			Relative humidity	: 60±5%RH					
			Air pressure	-					
2. App	earance, constr	uction and dimer	isions		·				
2-1. A	Appearance		There should be no o	defects that will de	egrade the sw	itch's perfori	mance.		
2-2 Co	onstruction and o	dimensions	Refer to individual pr	Refer to individual product drawing.					
			Push, tilting tactile fe	Push, tilting tactile feedback					
4. Contact arrangement 1 poles 1 throws, 1 pole 4 throws									
	kimum Rating		DC 12V ,50mA						
	formance								
6-1 E	lectrical perform	ance							
	Items		Test	conditions			Crite	eria	
6.1.1	Contact	Measurem				500MΩ MA	X		
	resistance	actuating (ush on and tilting such as FIG1 , FIG2) force with a 1KHz						
			tact resistance meter.						
6.1.2	Insulation	Measurem	ents shall be made by a	pplying a current	of 100V DC be	etween	100MΩ MI	N	
	resistance		nd frame or each termin						
6.1.3	Dielectric	A current o	f AC 500V (50Hz or 60H	lz) shall be applie	ed betweem te	rminals	There shou	ıld be no	
	withstanding		or each terminals for on				breakdown.		
6.1.4	Bounce	Shall be te	sted during the transitio	n of OFF to ON a	at a rate of thre	e	10m Sec m	nax	
		to four ope	rations per second.						
			5K ohm						
			5V SWITCH Scilloscope						
						APPD.	CHKD.	DSGE.	
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6-2.	Mechanical performa	nce	
	Items	Test conditions	Criteria
6.2.1	Actuating	Actuating force should be applied horizontal and vertical to the stem as	Push on : 250±80gf
	force	shown in Fig1 , Fig2. When actuate the stem, force should be applied	Tilting: 110±70g
		gradually.	
5.2.2	Stroke	The travel distance should be measured to the stem as shown in	Push on : 0.2±0.1mm
		Fig1(Push on) and Fig2(Tilting). When actuate the stem force should	Tilting: 0.5±0.2mm
		be applied gradually.	
5.2.3	Return force	The force of the stem to return to its free position shall be measured	Push on : 50gf Min
		after actuating force is applied as shown in Fig1, Fig2.	Tilting : 20gf Min
6.2.4	Stop strength	A static load of 3Kgf is applied to the horizontal and vertical direction	There shall be no sign
		as shown in Fig1 and 2 for a period of 60 seconds.	of damage mechanically
			and electrically.
6.2.5	Stem strength	A static load is applied to the pull direction there should be no damages.	500gf Min
		$\begin{array}{c} & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & &$	Tilting 12°
6-3.	Environmental perfor		
	Items	Test conditions	Criteria
6.3.1	Resistance to	When test being done under these condition, it should be tested after	Item 6-1
	low Temperature	one hour leave in normal temperature and humidity.	Item 6-2-1
		(1)Temperature : -40± 2 ℃	Item 6-2-2
		(2)Time : 96 hours	Item 6-2-3
		(3)Water drops shall be removed	Item 6-1
5.3.2	Heat resistance	eat resistance When test being done under these condition, it should be tested after	
		one hour leave in normal temperature and humidity.	Item 6-2-1
		(1)Temperature : +85± 2℃	Item 6-2-2
		(2)Time : 96 hours	Item 6-2-3
6.3.3	Moisture		Item 6-2-3 Item 6-1
6.3.3	Moisture resistance	(2)Time : 96 hours	
6.3.3		(2)Time : 96 hours When test being done under these condition , it should be tested after	Item 6-1
6.3.3		(2)Time : 96 hoursWhen test being done under these condition , it should be tested after one hour leave in normal temperature and humidity.	Item 6-1 Item 6-2-1

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	Items	Test conditions	Criteria			
6.3.4	Temperatu	re The test being conducted five times as shown in figure	e. Item 6-1			
	cycling	It should be tested after one hour leave in normal tem	perature and Item 6-2-1			
		humidity. During this test , water drops shall be remov	ed. Item 6-2-2			
		1 CYCLE	Item 6-2-3			
		+60				
		2H 1H 2H				
6-4. I	Endurance					
6.4.1	Operating I	 fe Measurements shall be made by following the test set (1)DC 5V 5mA resistive load. (2)Rate of operation : 2 to 3 operations per second. (3)Depression : 350gf Max (4)Cycle of operation : 250,000 cycies (each direction 	:1000m Max. Insulation resistance :10m Min.			
6.4.2	Vibration resistance	 Measurements shall be made by following the test set (1)Range of oscillation : 10 to 55Hz (2)Amplitude, peak-to-peak : 1.5mm (3)Cycle of sweep : 10-55-10Hz in one minute approxiding (4)Mode of sweep : Logarithmical sweep or uniform sweep (5)Direction of oscillation : Three mutually perpendicular including the direction of stem travel (6)Duration of testing : 2 hours each, for a total of 6 hours 	Item 6-2-1 Item 6-2-2 imate. Item 6-2-3 weep lar directions			
6.4.3	Impact sho Resistanc	ck Measurements shall be made by following the test set	. Item 6-1 Item 6-2-1			
7.Mat	erials 1) HOUSING (2) COVER 3) ACTUATOF 4) ACTUATOF 5) CONTACT	: SUS 1 (STEM 1) : LCP				

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3. Automatic soldering condition

3.1 Soldering

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3.1.1 Temperature : less than 260

3.1.2 Time : Continuous dipping duration shall not exceed 10 seconds.

3.1.3 Premissible soldering times: less than twice

(The second soldering would be conducted after the temperature goes down to a normal temperature)

- 3.2 Preheat
- 3.2.1 Temperature : less than 100

(Circumferential temperature of the printed circuit board)

3.2.2 Time: less than 45second

3.3 Flux streaming

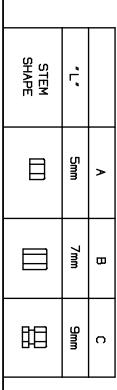
: flux streaming shall be controlled so that it shall not swell beyond the printed circuit board where components are installed.

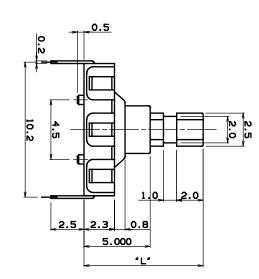
- 3.4 Other precautions
- 3.4.1 Flux shall not be applied to the switch terminals and the part mounting surface of the printed circuit board before soldering.
- 3.4.2 Do not wash the switch after soldering.

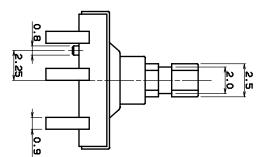
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Caution						
1. When termina	1. When terminals are exposed to mechanical stress during soldering, it may cause degradation in deformation and					
electrical prop	erty.					
2. Through-hole	PC board, or a PC board thickness other than the recommendation may cause larger h	neat stress.				
Prior verification	on is highly recommended.					
3. In prior to the 2	2nd soldering switch shall be stable with normal temperature. It may cause deformation	n of switch,				
loose terminal	s, terminal removed from PCB, and / or degradation of electric property.					
4. Verify samples	s with actual mass production conditions.					
5. The products a	are designed and manufactured for direct current resistance. Individual consultation is	recommended				
for use of othe	r resistances such as inductive (L) or capacitive (C) .					
6. The sizes of ho	les and patterns on a PC board for mounting a switch, be as per the recommended dir	mensions in				
the product dra	wings.					
7. This switch is c	lesigned for manually operated units. Must not use this switch for a mechanical detecti	on unit. For				
detection purpo	oses, please use our detection switch.					
8. The switch will	be break if impact force or a greater stress than that specified is applied. Take great ca	are not to				
let the switch b	e subject to greater stress than specified.					
	force from the side of the stem					
	h the center of switch for "without-stem" type. Extreme care is required for a hinge stru	icture type.				
	as the activation point may shift when it is pressed down.					
	ting (software setting) shall be ensured for error-free operations, caused by bounce and	d chattering				
	as specified by each model of the switches.					
	12. Prior verification is needed to ensure that no corrosive gas-generating components are used near our switch. It					
may give negative influence such as contact failure.						
13. Contact resistance of a carbon contact type may very depending on push force. Confirm that it functions						
sufficiently in using TACT switch with a voltage divider circuit.						
14. Be aware of dust intrusion into a non dust-proof TACT switch.						
15. Storage						
-	products as delivered, at a normal temperature and humidity, without direct sunshine a	and				
-	s ambient. Use them at an earliest possible timing, not later than six months upon rece					
	g the seal, keep the products in a plastic bag to prevent out ambient air, store them in					
	as above, and use all as soon as possible.					
	too many switches.					
	y switches in released position.					
-	n can be changed to improve performance without any notice.					

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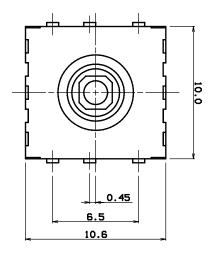
A A NO. DATE <u>к</u>. PART NAME NOTE SIGN 340 MIGLE PROJECTION NPPROVED 0'TY UNIT CHECKED MATERIAL m/m SCALE DESIGNED DWG.NAME MODEL DWG.NO. SIZE A'SSY DIAGRAM MT 1500D TYPE TREAT. REMARKS

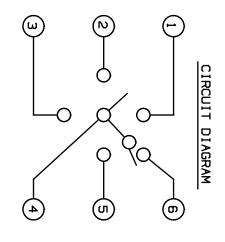


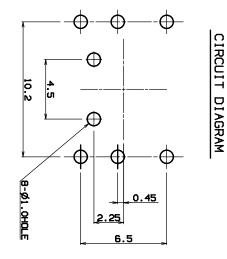




3.RATING : MAX 50mA . 12V DC 6.FEATURE : MULTI THIN TYPE, REFLOW SOLDERING 5. CONTACT RESISTRANCE : 100mg MAX 4.STROKE (mm) : 4-DIRECTION 0.4 ±0.1 , CENTER : 0.2±0.1 2.LIFE CYCLE : FOR EACH 50,000 CYCLE 1. OPERAING FORCE : 4-DIRECTION 160 ±30 . CENTER : 320 ±70







NOTE